



Integrated Device Technology, Inc.
6024 Silver Creek Valley Road, San Jose, CA - 95138

PRODUCT/PROCESS CHANGE NOTICE (PCN)

PCN #: TB1407-02	DATE: 25-Jul-2014	MEANS OF DISTINGUISHING CHANGED DEVICES:
Product Affected: 4RCD0124KC0ATG, 4RCD0124KC0ATG8, 4RCD0124KC0ATG/M, 4RCD0124KC0ATG8/M		☐ Product Mark ☐ Back Mark ☐ Date Code ☒ Other
Date Effective: 25-Aug-2014		Traceability to the test location is maintained by IDT and available on request

Contact: IDT PCN DESK	Attachment: ☒ Yes ☐ No
E-mail: pcndesk@idt.com	Samples: Please contact your local sales representative for sample request.

DESCRIPTION AND PURPOSE OF CHANGE:

☐ Die Technology ☐ Wafer Fabrication Process ☐ Assembly Process ☐ Equipment ☐ Material ☐ Testing ☒ Manufacturing Site ☐ Data Sheet ☐ Other	This notification is to advise our customers that IDT is adding ASEK, Taiwan as an alternate facility for Test process for the selective products that are presently tested at IDT Penang, Malaysia facility. Products tested in ASEK will also complete the Backend process in this same facility. Products tested and backend processed in ASEK will be available to ship upon successful completion of the test correlation. Attachment I details the change.
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RELIABILITY/QUALIFICATION SUMMARY:

Electrical correlation data will be available upon successful completion of the test correlation.

CUSTOMER ACKNOWLEDGMENT OF RECEIPT:

IDT records indicate that you require written notification of this change. Please use the acknowledgement below or E-Mail to grant approval or request additional information. If IDT does not receive acknowledgement within 30 days of this notice it will be assumed that this change is acceptable.
IDT reserves the right to ship either version manufactured after the process change effective date until the inventory on the earlier version has been depleted.

Customer: _____	☐ Approval for shipments prior to effective date.
Name/Date: _____	E-Mail Address: _____
Title: _____	Phone# /Fax# : _____

CUSTOMER COMMENTS:

IDT ACKNOWLEDGMENT OF RECEIPT:

RECD. BY: _____ DATE: _____



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ATTACHMENT I - PCN # : TB1407-02

PCN Type: Manufacturing Site - Alternate Test & Backend Location

Data Sheet Change: None

Detail Of Change:

This notification is to advise our customers that IDT is adding ASEK, Taiwan as an alternate facility for Test process for the selective products that are presently tested at IDT Penang, Malaysia facility. Products tested in ASEK will also complete the Backend process in this same facility.

This change will allow IDT the flexibility to ship from either facility and will provide the increased capacity, flexibility and shorter lead time to meet market demand.

The test correlation plan will ensure that the testing is fully compatible and transferable between the test sites with no change to the test coverage, test configuration or test flow. The Backend process is standardized between the 2 sites. There will be no change to the Backend process without further notification to customers. Upon successful completion of the test correlation plan, products tested at ASEK will be available to ship.

There is no change in the moisture sensitivity level (MSL).

If you require samples to conduct evaluations, please contact your local sales representative to acknowledge this PCN and request samples.